

## 771B AND 771BX ELECTRONIC CROSSOVER BIAMPLIFIERS

OPERATING INSTRUCTIONS



ALTEC 771B and 771BX Electronic Crossover Biamplifiers improve power handling and reduce distortion without requiring a high-power amplifier and separate crossover network.

#### **FEATURES**:

Electronic Crossover with Separate Power Amplifiers

Heavy LF Demands Do Not Affect HF Performance

Full Amplifier Power and Efficiency

Versatile Input Connections

Fail–Safe Protection for Output Transistors

Export Model

These ALTEC biamplifiers include electronic crossover circuitry and separate low-frequency (LF) and high-frequency (HF) amplifiers in a single, compact package that can be mounted directly in the speaker enclosure. The electronic crossover circuit divides the input signal into separate bass and treble channels. A 60-watt LF amplifier drives the bass speaker and a 30-watt HF amplifier drives the horn-loaded compression driver.

Extreme LF power demand does not affect HF reproduction because separate amplifiers drive the LF and HF speakers.

The electronic crossover is placed ahead of the dual power amplifiers so that full biamplifier output is distributed to the speakers.

Standard input connections are direct coupled. Transformer isolation of the input is accomplished with an optional plug-in transformer. Input interconnection phono jacks (771B only) permit connecting up to 20 biamplifiers into a single sound system.

ALTEC's Active Dissipation Sensing Circuit provides fail-safe protection for the output transistors. The action of the sensing circuit is immediate and effective at all frequencies within the passband of the biamplifier, limiting only that portion of the program material that would damage or degrade the performance of the output transistors.

The ALTEC 771BX Biamplifier (export model) is similar to the 771B, except that voltage selection and fusing is provided for primary power. The jack for connecting two or more biamplifiers into multiple systems is not provided.

Specifications and components subject to change without notice. Overall performance will be maintained or improved.

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# **SPECIFICATIONS**

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Туре:	Biamplifier with electronic cross- over	Controls (Cont'd):	1 ELECTRONIC CROSSOVER FREQUENCY switch, 500 Hz/800
Gain (with Full Boost) —			1 POWER switch
Bass Amplifier:	52 dB with 15356 Line Matching Transformer 66 dB with 15095 Line Matching Transformer 40 dB with 15256 Line Matching		1 PRESS TO RESET pushbutton (circuit breaker). Model 771B only.
Treble Amplifier:	Transformer 63 dB with 15095 Line Matching Transformer		1 VOLTAGE SELECT switch. Model 771BX only.
Input Sensitivity (for Rated Output with Full Boost):	0.5V rms direct 0.5V rms with 15356 Line Match- ing Transformer (high-level bal- anced-line matched input) 0.1V rms with 15095 Line Match- ing Transformer (high-level bal- anced-line matched input)	Power Requirements: Dimensions — Overall:	120V, 50/60 Hz ,90 watts. Model 771BX only. Selectable 95 V to 240V, 50/60 Hz , 90 watts. Model 771BX only. 6–1/2" H x 9–7/8" W x 9" D
Power Output — Bass Amplifier: Treble Amplifier:	60 watts at less than 0.5% THD 30 watts at less than 0.5% THD	Weight:	16 pounds
Total Harmonic Distortion (THD):	Less than 0.5% at rated power, 20 Hz to 20 kHz	Color: Accessories:	Black ALTEC 15095 Line Matching Transformer (bigb-loval balanced
IM Distortion:	Un measurable by normal IHF method		line matched input)
Crossover Frequency:	500, 800 or 1500 Hz with –12 dB/ octave slope		Transformer (high-level balanced- line matched input)
Frequency Response:	±1 dB from 20 Hz to 20 kHz (nor- malized composite output)	Accessories MUS	-NOTE
Input Impedance:	80,000 ohms direct 600 ohms with 15356 or 15095 transformer	INSTALLAT	tion hardware supplied
Load Impedance:	8 ohms nominal for each amplifier	6 - screws, 8-32	2" × 1-1/4"
Damping Factor:	25	6 - 'T' nuts, 8-3	32"
Noise Level:	80 dB below rated output	1 - Cable, 25 fe	eet with phone plugs
Controls:	1 BASS GAIN CONTROL, con- tinuously variable, +6 dB to -15 dB	4 – Speaker con connectors	necting wires with push-on
	1 TREBLE GAIN CONTROL, con- tinuously variable, +6 dB to -15 dB		

## **OPERATION**

## CONTROLS

All normal operating controls and input jacks are located on the front panel (see Figure 1). Descriptions and functions of controls and connections are listed in Table 1.

## NORMAL CONTROL SETTINGS

Recommended initial settings of the BASS and TREBLE GAIN CONTROLS are at 0 dB. Adjust sound-system volume at mixer/amplifier or other input device, then use the BASS and TREBLE GAIN CONTROLS to boost or attenuate the low and high frequencies for desired results.

## VENTILATION

Air must circulate freely past the front panel of the biamplifier for best performance. When moving or positioning the speaker enclosure containing the biamplifier, be sure free circulation of air past the heat-dissipating vanes is not restricted by curtains, furniture, walls or other equipment. Allow at least two inches of space in front of the vanes.

## USING INPUT TERMINAL BOARD

The INPUT terminal board (see Table 1 and Figure 1) permits either direct coupling or transformer isolation of the input. For direct coupling, connect the input leads (shielded conductor recommended) to terminals 1 and 2; terminal 2 is ground. For transformer-isolated

ltem	Name	Function/Description
1	BASS and TREBLE GAIN CONTROL potentiometers	Provide separate control of bass and treble portions of input signal. Each control is continuously variable from +6 to -15 dB. Raise controls for gain, lower controls for attenuation. Controls are linear, slide-type potenti- ometer.
2	FROM MIXER PREAMPLIFIER jack	Connects (direct coupling) input signal from mixer, preamplifier or other input device. Model 771B can accept an input signal from another 771B (or 771A).
3	INPUT terminal board	Provides alternate direct coupling of input signal. Transformer isolation of input signal may be obtained when an optional ALTEC plug-in transformer accessory is used.
4	TO ADDITIONAL POWER SPEAKER jack	Connects another 771B in parallel to enlarge the sound system.
5	POWER switch	Applies primary power. Pilot light in switch (771B only) is lit when power is on.
6	PRESS TO RESET pushbutton	Restores primary power if protective circuit breaker is open (771B only). If circuit breaker opens repeatedly, cause should be corrected before resetting.
7	VOLTAGE SELECT switch	Must be set to appropriate voltage range before turning on amplifier (771BX only). Selects proper transformer primary configuration for line voltages of 95 to 240V, 50/60 Hz. CAUTION — Turning switch with primary power applied to amplifier may damage or burn out switch.
8	30 WATTS – 60 WATTS speaker terminals	Connect HF and LF speakers. Terminals accept push-on connectors without soldering.
9	ELECTRONIC CROSSOVER FREQUENCY switch	Selects 500, 800 or 1500 Hz crossover frequency according to optimum requirements of speaker system.

#### Table I. Operating Controls and Features





Model 771BX



Side and Rear View

Figure 1. Controls and Features

coupling, connect the input leads to terminals 3 and 4. Transformer-isolated coupling also requires installation of a plug-in ALTEC transformer accessory.

OPTIONAL PLUG-IN INPUT TRANSFORMER ACCES-SORIES

The ALTEC 15356 and 15095 Line Matching Transformers provide a high-level balanced input capability for the biamplifier. The 15356 has a 0.5V rms input sensitivity for full rated biamplifier output. Input sensitivity with the 15095 is 0.1V rms for full rated output.

CONNECTING 771Bs IN MULTIPLE SYSTEMS

Each 771B is provided with an interconnecting cable to combine an additional 771B into the sound system. Up to 20 of the 771Bs may be connected into a single sound system in this manner. Speaker hook up and parallel multiple-system interconnections are shown in Figure 2. The input signal cable is plugged into the FROM MIXER PREAMPLIFIER jack. The next 771B is connected in parallel by plugging the provided interconnecting cable into the TO ADDITIONAL POWER SPEAKER jack on the first 771B and into the FROM PREAMPLIFIER jack on the second 771B. Continue this interconnection method to combine as many 771Bs as required (up to 20 units).



Figure 2. Speaker Hookup and 771B Interconnectios

#### INSTALLATION

The 771B and 771BX are designed to be installed at a convenient location in the speaker enclosure. If installation is made in an existing speaker system, the passive crossover network already present in the system must be removed because the biamplifier contains an electronic crossover circuit.

If the biamplifier is to be installed in an enclosure not previously prepared for its installation, complete all steps of the following procedure. If the biamplifier is to be installed in an ALTEC enclosure specifically prepared for it, complete only Steps 5, 6 and 7 of the installation procedure.

- Step 1. Cut rectangular hole 5-1/2" high by 9-1/2" wide in enclosure at desired location. Note required depth to accommodate biamplifier is 9".
- Step 2. Insert biamplifier in cutout and mark center points for each of six holes to be drilled for securing hardware. Remove biamplifier.
- Step 3. Use 7/32" (0.218") to drill and bore holes, located in Step 2, to accept shaft of 8-32" 'T' nuts supplied with biamplifier. Remove debris from enclosure and edges of holes.
- Step 4. Insert six 'T' nuts in mounting holes from inner side of enclosure. Gently hammer each in place until 'T' nut faces are flush with enclosure surface.
- Step 5. Install supplied speaker wires on speakers and biamplifier speaker terminals (see Figure 2). Note that minimum speaker impedance is eight ohms.
- Step 6. Verify that ELECTRONIC CROSSOVER FRE-QUENCY switch is set to appropriate 500, 800 or 1500 Hz position, as required by speaker system.
- Step 7. Insert biamplifier in cutout and secure it to 'T' nuts with six (6) 8-32" x 1-1/4"screws (supplied).

# SERVICE AND MAINTENANCE INSTRUCTIONS

This service information is for the use of authorized warranty stations (dealers) only. Service must be performed by an ALTEC Qualified Service Representative.

# NOTICE

REPAIR PERFORMED BY OTHER THAN AUTHOR-IZED WARRANTY STATIONS (DEALERS) OR OTHER QUALIFIED PERSONNEL SHALL VOID THE WARRANTY PERIOD OF THIS UNIT. TO AVOID LOSS OF WARRANTY, SEE YOUR NEAR-EST ALTEC AUTHORIZED DEALER OR CALL ALTEC CUSTOMER SERVICE DIRECTLY AT (714) 774-2900, OR WRITE:

> Customer Service ALTEC 1515 South Manchester Avenue Anaheim, California 92803

#### ACCESS

Remove the eight screws securing the cover to the chassis. Carefully slide cover off, flexing it slightly to clear the screws that attach the speaker terminal bracket.

#### Installing Plug-In Input Transformer Accessories

Verify line power is turned off, then remove chassis cover. Carefully plug the accessory input transformer into the octal socket (J3) in the chassis (see Figure 3), then replace chassis cover and secure with eight screws previously removed.

#### Power Driver Bias Adjustment

Adjustment of the power driver bias control(s) may be required when replacing a power transistor or power driver printed circuit board (PCB). One bias adjusting control is located on each power driver PCB; R12 on the HF power driver PCB and R13 on the LF power driver PCB (see Figures 3 and 9). These controls set the bias for proper crossover between negative and positive signal components of power transistors Q1 and Q2 (HF); Q3 and Q4 (LF) (see Figures 3 and 5). Improper adjustment of these controls results in distortion at the crossover frequency. To adjust either R12 or R13, use the following procedure:

1. Verify line power is turned off, then remove chassis cover.

- If adjusting R12, set a dc VTVM to scale that will conveniently read 20 mV and connect its positive (+) lead to Q1 emitter and its negative (-) lead to Q2 collector (see Figure 4, Motorola MJE).
- If adjusting R13, set a dc VTVM to scale that will conveniently read 20 mV and connect its positive (+) lead to Q3 emitter and its negative (-) lead to Q4 collector (see Figure 4, Motorola MJE).
- 4. Turn on line power to biamplifier.
- Observe VTVM; it should read approximately 17.5 mV.
- Adjust bias control (R12 or R13), as necessary (see Figure 3). Clockwise adjustment increases voltage, counterclockwise adjustment decreases voltage.
- Allow stabilization 15 to 30 minutes for drift check. If dc voltage reading changes more than ±15 mV, readjust bias control for 17.5 mV.
- Turn off line power, disconnect VTVM, replace chassis cover and secure with eight screws previously removed.



Figure 3. Biamplifier Interior

#### PCB Replacement

A crossover PCB and two power driver PCBs are located within the chassis (see Figures 3 and 6). Use the following procedure to replace a failed PCB with a new or repaired PCB.

- 1. Verify line power is turned off, then remove chassis cover.
- 2. If a power driver PCB is being replaced, carefully remove cable connector from jack on PCB.
- 3. Carefully remove PCB from standoffs, loosening evenly at each corner.

Do not warp, bend or twist the board or conductor may fracture.

- 4. Carefully press new or repaired PCB into place on standoffs. Press corners in place evenly until plastic fasteners lock PCB in position.
- If a power driver PCB is replaced, carefully press cable connector, previously removed, onto jack on PCB. Verify that power driver bias adjustment is correct and readjust if necessary. Refer to <u>Power</u> Driver Bias Adjustment procedure.
- 6. Replace chassis cover and secure with eight screws previously removed.

#### RECOMMENDED SERVICE TECHNIQUES

If systematic troubleshooting shows need for parts replacement, observe the following precaustions.

#### Transistor Orientation

Solid-state components are packaged in various case sizes and types with various lead orientations (see Figure 4). Before removing a solid-state component from tie points or from a PCB, sketch the lead orientation with respect to the tie points or PCB.

Form the leads of the new component to conform with the leads of the part being replaced to aid in making proper connections.

Before removing small transistors, note position of index tab with respect to the PCB or socket. Cut the leads of the new transistor to the required length and insert them into the PCB or socket properly indexed.

#### **Replacing Power Transistors**

Be sure the following conditions exist when replacing power transistors.



Figure 4. Typical Solid–State Component Configurations

- 1. The mica insulator is not damaged. If damaged, use new insulator.
- 2. No grit or metal particles are between replacement transistor and heat sink.
- 3. Both side of mica insulator are covered with silicone grease or fluid.
- 4. Mounting screws are tight (see Figure 5).

Install concave washer on power transistor with concave surface DOWN; otherwise, power transistor may fracture.



Figure 5. Power Transistor Installation

#### **Testing Transistors**

Transistors should be checked with a transistor tester. If a tester is not available, use the following procedure for testing transistors with an ohmmeter.

- Step 1. Remove suspected transistor from circuit (see Replacing PCB Components).
- Step 2. Connect ohmmeter leads to base and emitter. Read on lowest ohms scale. Reverse leads and read again. Normal readings should be at least 10 times greater in one direction than in the other.
- Step 3. Connect ohmmeter leads to base and collector and repeat Step 2. Ohmmeter readings should be similar to those obtained in Step 2.
- Step 4. If Steps 2 and 3 show normal function, connect ohmmeter leads to collector and emitter. Read on lowest ohms scale. Reverse leads and read again. If reading is low and virtually unchanged when ohmmeter leads are reversed, the transistor has a short circuit between collector and emitter.

#### Replacing PCB Components

The main chass is schematic for the 771B is shown in Figure 6 and the main chassis schematic for the 771BX is shown in Figure 7. Component locations on the PCBs are shown in Figures 8, 10 and 12. PCB schematics are shown in Figures 9, 11 and 13. Before removing PCB components for testing or replacement, read and heed the following instructions.

- Solid-state components and PCBs may be damaged by excessive heat. Use a small soldering iron with a 1/8-inch diameter chisel tip. Use small-diameter, 60/40 rosin-cored solder.
- 2. Remove components by placing soldering iron on component lead on conductor side of PCB and pull out lead. Avoid overheating the conductor.

CAUTION — The conductor on the PCB is a metal surface plated with solder and laminated to the board. Too much pressure or overheating may lift the conductor from the board.

- If component is faulty or damaged, clip leads close to component and then unsolder leads from board. Withdraw leads from component side.
- 4. Clear solder from circuit board holes before inserting leads of new component. Heat solder remaining in hole, remove iron and quickly insert a pointed nonmetallic object, such as a toothpick from conductor side.
- Shape new component leads and clip to proper length. Lead shape should provide stress relief for component. Insert leads in holes, observing same polarity or orientation of removed component. Apply heat and solder on conductor side.

#### Repairing Fractured or Damaged PCB Conductor

If a conductor is fractured, damaged or lifted from the circuit board, a recommended method of repair is to solder a section of good conducting wire along the damaged area and seal with epoxy.



Figure 6. Schematic (3D212-1), 771B Electronic Crossover Biamplifier

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Figure 7. Schematic (3D228-1), 771BX Electronic Crossover Biamplifier

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Figure 8. Electronic Part Locations (2C573-4), LF Power Driver PCB Assembly





Figure 9. Schematic (2D544-7), LF Power Driver PCB Assembly



Figure 10. Electronic Part Locations (2C572-3), HF Power Driver PCB Assembly



HIGHEST REF DESIGNATIONS USED				
C8	CRS	<i>J1</i>	R20	
REFERENCE DESIGNATIONS NOT USED				
	_			

Figure 11. Schematic (2D545-4), HF Power Driver PCB Assembly



Figure 12. Electronic Part Locations (3C065-1), Crossover PCB Assembly



				-
R24	CIO	0.3	SI	
				1
REFEREN	ICE DESI	GNATION	NOT US	ED
	0.0	1		_

Figure 13. Schematic (3C066-2), Crossover PCB Assembly

# PARTS LIST

## 771B/771BX MAIN CHASSIS

Reference	Ordering	Name and
Designator		Description
A1	27-01-042638-01	PCB assembly, cross – over
A2	27-01-042245-01	PCB assembly, HF
А3	27-01-042244-01	PCB assembly, LF
CI	15-01-100296-01	F, 25√, 25√, Cap., 5000
C2	15-01-107511-01	Cap., 6200 µF, 75∨
C3	15-01-100298-01	F,60V پر Cap., 5000 پF
C4	15-01-100279-01	Cap., 500 μF, 50∨
C5	15-01-114352-01	F,50V µF,50∨
C6,7	15-06-102605-01	Cap.,0.47µF±10%, 100∨
C8	15-02-100089-01	Cap. , 0.01µF ±20%, 4000∨
CB1 (771B only)	51-03-109809-02	Circuit breaker, 2.2A hold, 3.25A trip
CRI	48-02-108577-01	Diode bridge recti- fier, 1.5A, 100 PIV
CR2,3,4,5	48-02-107467-01	Diode, rectifier, 1N5402,200V, 3A
CR6,7,9,10	48-01-109275-01	Diode, Zener, 1N746,3.3V±10%, 400 mW
CR8,11	48-01-107429-01	Diode, stabistor, 3– pellet
F1,2	51-04-100462-01	Fuse, 1/4A, 3AG, 250V
F3,4 (771BX only)	51-04-100464-01	Fuse, 1A, 3AG
JI <sup>()</sup>	21-01-114347-01	Jack
J2 (771B only)	21-01-114347-01	Jack

Reference Designator	Ordering Number	Name and Description
J3 Q1,2,3,4	21-02-100973-01 48-03-109715-02	Socket, octal Transistor
R1,3	47-06-042269-02	Pot., 10K Ω, B taper
R2,4	47-01-102163-01	Res., 1KΩ±10%, 1/4W
R5,7	47-02-107434-01	Res., 0.33 Ω ±10%, 3W
R6,8	47-02-108238-01	Res., 0.25 Ω ±10%, 3W
R9,10	47-02-112166-01	Res., 5 $\Omega$ ±10%, 5W
R11,12 (771BX only)	47-01-102359-01	Res., 2.2K Ω±10%, 1/2W
R13 (771BX only)	47-01-102075-01	Res., 750 Ω ±5%, 1/4W
S1 (771B only)	51-02-113986-01	Switch assembly, DPDT, w/pilot lamp
S1 (771BX	51-02-113535-01	Switch, SPDT, slide
S2 (771BX only)	51-01-042617-01	Switch, 2–gang,
T1 (771B only)	56-08-007458-01	Transformer, power
T1 (771BX only)	56-08-007543-01	Transformer, power
ТВ9	21-04-101038-01	Terminal board, 4-
TB11	21-04-030799-01	Terminal board, 4-
W1,2	60-09-042284-02	Cable assembly

# PARTS LIST (continued)

# LF POWER DRIVER PCB ASSEMBLY

Reference Designator	Ordering Number	Name and Description
C1 C2,6,13 C3.7	15-01-107452-01 15-01-100241-01 15-01-110771-01	Cap., 10 بF, 50V Cap., 50 بF, 50V Cap., 50 بF, 50V
C4	15-01-107500-01	Cap., $100  \mu F$ , $50V$
C5,9,10	15-06-108173-01	Cap., 0.47µF±20%,
C8	15-02-107454-01	Cap., 100 pF±10%, 100∨
C11,12	15-02-100307-01	Cap., 0.01 µF, ±20%, 100∨
C14	15-02-100302-01	Cap., 470 pF±10%, 100∨
CR1,2,3,4,5	48-01-107017-01	Diode, 1N456A, 25V,100 mA
CR6,7	48-01-102592-01	Diode
CR8	48-01-110786-01	Diode, Zener, 23V ±5%, 2W
۱۲	21-01-109731-01	Jack, phono
Q1,2	48-03-110773-01	Transistor , PNP, 50V
Q3,7	48-03-107447-02	Transistor, 2N5320, NPN, 10W, 75V
Q4	48-03-041440-01	Transistor, PNP
Q5	48-03-101098-01	Transistor, NPN
Q6	48-03-107448-02	Transistor, 2N5322, PNP, 10W, 75V
R1,9	47-01-102178-01	Res., 18K Ω ±10%, 1/4W
R2	47-01-102181-01	Res., 33KΩ ±10%, 1/4W
R3	47-01-102116-01	Res., 39KΩ±5%, 1/4W
R4	47-01-102155-01	Res., 220 Ω ±10%, 1/4W

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Reference Designator	Ordering Number	Name and Description
R5,6	47-01-102169-01	Res., 3.3K Ω±10%, 1/4W
R7,16,17 25,27	47-01-102151-01	Res., 100Ω±10%, 1/4W
R8	47-01-102067-01	Res., 360Ω±5%, 1/4W
R10	47-01-102183-01	Res., 47K Ω ±10%, 1/4W
R11,12	47-01-102359-01	Res., 2.2K Ω±10%,
R13	47-05-107504-01	Pot., 500 Ω ±20%, 2W
R14	47-01-102140-01	Res., $10 \Omega \pm 10\%$ , $1/4W$
R15	47-01-102147-01	Res., 47Ω±10%, 1/4W
R18,19, 20,30	47-01-102171-01	Res., 4.7K Ω±10%,
R21	47-01-102156-01	1/4W Res., 270 Ω ±10%,
R22,23	47-01-102167-01	1/4W Res., 2.2K Ω±10%,
R24,26	47-01-102152-01	1/4W Res., 120 Ω ±10%,
R29	47-01-102157-01	1/4W Res., 330 Ω ±10%,
R31	47-01-000001-01	1/4W Res. , value specially
		selected in test, ±5%, 1/4W
R32	47-01-102163-01	Res., 1K Ω ±10%, 1/4W

## PARTS LIST (continued)

## HF POWER DRIVER PCB ASSEMBLY

Reference Designator	Ordering Number	Name and Description
Cl	15-06-100311-01	Cap., 0.1 µF±20%, 250∨
C2,4	15-01-107501-01	F, 50V, 25 پاCap., 25
C3,7	15-01-110771-01	Cap., 5 μF, 50V
C5	15-06-108173-01	Cap., 0.47µF ±20%, 100∨
C6	15-01-100241-01	F 50V µF 50V
C8	15-02-107454-01	Cap., 100 pF±10%, 100∨
С9	15-02-100302-01	Cap., 470 pF±10%, 100∨
CR1,2,3	48-01-102592-01	Diode
JI	21-01-109731-01	Jack, phono
Q1,2	48-03-108557-02	Transistor, 2N5367, PNP, 0.36W, 40V
Q3,7	48-03-107447-02	Transistor, 2N5320, NPN, 10W, 75V
Q4	48-03-101098-01	Transistor
Q5	48-03-041440-01	Transistor
Q6	48-03-107448-02	Transistor, 2N5322, PNP, 10W, 75V

Reference Designator	Ordering Number	Name and Description
R1,8	47-01-102181-01	Res., 33K Ω ±10%, 1/4W
R2,3,14,16	47-01-102175-01	Res., 10K Ω ±10%, 1/4W
R4	47-01-102159-01	Res., 470Ω ±10%, 1/4W
R5, 6, 15, 17	47-01-102169-01	Res., 3.3K Ω±10%, 1/4W
R7,21	47-01-102163-01	Res., 1KΩ±10%, 1/4W
R9	47-01-102183-01	Res., 47K Ω ±10%,
R10,11	47-01-102359-01	Res., 2.2K Ω±10%,
R12	47-05-107504-01	Pot., 500 Ω ±20%, 2W
R13,20	47-01-102156-01	Res., 270 Ω ±10%, 1/4W
R18,19	47-01-102151-01	Res., 100 Ω ±10%, 1/4W

# PARTS LIST (continued)

## CROSSOVER PCB ASSEMBLY

Reference Designator	Ordering Number	Name and Description
C1,2	15-01-108543-01	Cap., 5 µF, 25∨
$C_3$	15-01-100241-01	Cap., 50 µF, 50V
C4,9,10	15-01-10/495-01	Cap., 25 µF ±10%, 25∨
C5	15-06-051240-02	Cap., 0.025 µF ±5%, 100∨
C6,7,8	15-06-109091-01	Cap.,0.012µF ±5%, 100∨
Q1,2,3	48-03-041627-01	Transistor
R1	47-01-100482-01	Res., 1MΩ ±10%, 1/4W
R2,3	47-01-102187-01	Res., 100 K Ω±10%, 1/4W
R4	47-01-102191-01	Res., 220K Ω±10%, 1/4W
R5	47-01-102169-01	Res., 3.3K Ω±10%, 1/4W
R6,17	47-01-102179-01	Res., 22KΩ±10%, 1/4W

Reference Designator	Ordering Number	Name and Description
R7,11,12	47-01-102108-01	Res., 18KΩ±5%, 1/4W
R8,10,21	47-01-102114-01	Res., 33KΩ±5%, 1/4W
R9	47-01-102106-01	Res., 15KΩ±5%, 1/4W
R13	47-01-102123-01	Res., 68KΩ±5%, 1/4W
R14	47-01-102116-01	Res., 39K Ω ±5%, 1/4W
R16,19	47-01-102094-01	Res., 4.7K Ω ±5%,
R20	47-01-102163-01	Res., 1KΩ±10%, 1/4W
R22,24	47-01-102101-01	Res., 9.1K Ω ±5%, 1/4W
R23	47-01-102109-01	Res., 20K Ω ±5%, 1/4W
S1	57-02-042698-01	Switch, slide, 4P3T